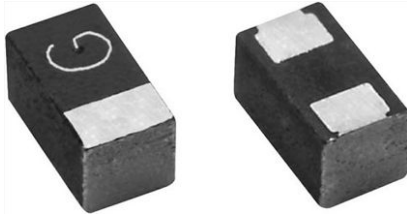


Solid Tantalum Chip Capacitors MICROTAN[®] Low ESR, Leadframeless Molded


FEATURES

- Lead (Pb)-free face-down terminations
- Mounting: Surface mount
- 8 mm tape and reel packaging available per EIA-481 and reeling per IEC 60286-3 7" [178 mm] standard
- Low ESR
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
GREEN
(5-2008)

PERFORMANCE CHARACTERISTICS

Operating Temperature: - 55 °C to + 125 °C
(above 85 °C, voltage derating is required)

Capacitance Range: 1 μF to 220 μF

Capacitance Tolerance: ± 20 % standard, ± 10 % available

Voltage Range: 4 V_{DC} to 16 V_{DC}

| ORDERING INFORMATION | | | | | | |
|-----------------------------|--|---|--|--|---|---|
| TR8 TYPE | M CASE CODE | 106 CAPACITANCE | M CAPACITANCE TOLERANCE | 6R3 DC VOLTAGE RATING AT + 85 °C | C TERMINATION | 2000 ESR |
| | See Ratings and Case Codes table | This is expressed in picofarads. The first two digits are the significant figures. The third is the number of zeros to follow. | K = ± 10 % M = ± 20 % | This is expressed in volts. To complete the three-digit block, zeros precede the voltage rating. A decimal point is indicated by an "R" (6R3 = 6.3 V). | C = 100 % tin 7" [178 mm] reel A = Gold/7" [178 mm] reel | Maximum 100 kHz ESR in (mΩ) See note below. |

Note

- We reserve the right to supply higher voltage ratings and tighter capacitance tolerance capacitors in the same case size. Voltage substitutions will be marked with the higher voltage rating. Low ESR solid tantalum chip capacitors allow delta ESR of 1.25 times the datasheet limit after mounting.

| DIMENSIONS in inches [millimeters] | | | | | | |
|---|--------------------------------|--------------------------------|-----------------|-------------------------------|-----------------|-------------------------------|
| | | | | | | |
| CASE CODE | L | W | H (MAX.) | P1 | P2 (REF.) | C |
| M | 0.063 ± 0.008 [1.60 ± 0.2] | 0.033 ± 0.008 [0.85 ± 0.2] | 0.035 [0.9] | 0.020 ± 0.004 [0.50 ± 0.1] | 0.024 [0.60] | 0.024 ± 0.004 [0.60 ± 0.1] |
| R | 0.081 ± 0.006 [2.06 ± 0.15] | 0.053 ± 0.006 [1.35 ± 0.15] | 0.062 [1.57] | 0.020 ± 0.004 [0.51 ± 0.1] | 0.043 [1.10] | 0.035 ± 0.004 [0.90 ± 0.1] |
| P | 0.094 ± 0.004 [2.4 ± 0.1] | 0.057 ± 0.004 [1.45 ± 0.1] | 0.047 [1.2] | 0.020 ± 0.004 [0.50 ± 0.1] | 0.057 [1.40] | 0.035 ± 0.004 [0.90 ± 0.1] |
| Q | 0.126 ± 0.008 [3.2 ± 0.2] | 0.063 ± 0.008 [1.6 ± 0.2] | 0.039 [1.0] | 0.031 ± 0.004 [0.80 ± 0.1] | 0.063 [1.60] | 0.047 ± 0.004 [1.20 ± 0.1] |
| A | 0.126 ± 0.008 [3.2 ± 0.2] | 0.063 ± 0.008 [1.6 ± 0.2] | 0.071 [1.8] | 0.031 ± 0.004 [0.80 ± 0.1] | 0.063 [1.60] | 0.047 ± 0.004 [1.20 ± 0.1] |

| RATINGS AND CASE CODES | | | | | | |
|-------------------------------|-------|-----|-------|------|------|------|
| μF | 2.5 V | 4 V | 6.3 V | 10 V | 16 V | 25 V |
| 1.0 | | | | | M | |
| 2.2 | | | | M | M | |
| 4.7 | | | | M | M | |
| 10 | | | M | M | R | A |
| 15 | | | M | M | | |
| 22 | | | M | | | |
| 33 | | M | M | P | | |
| 47 | | M | | P | | |
| 100 | | P | P/A | | | |
| 220 | P | P/Q | | | | |

| MARKING | | | |
|----------------------|------|--------------------------|-----------|
| <p>M-Case</p> | | <p>P-, R-Case</p> | |
| | | <p>A-, Q-Case</p> | |
| VOLTAGE CODE | | CAPACITANCE CODE | |
| V | CODE | CAP, μF | CODE |
| 2.5 | e | 10 | α |
| 4.0 | G | 33 | n |
| 6.3 | J | 47 | s |
| 10 | A | 68 | w |
| 16 | C | 100 | \bar{A} |
| 20 | D | 150 | \bar{E} |
| 25 | E | 220 | \bar{J} |



| STANDARD RATINGS | | | | | | |
|--|--------------|--------------------|--------------------------------------|------------------------------|---|--|
| CAPACITANCE (μ F) | CASE CODE | PART NUMBER | MAX. DCL AT + 25 °C (μ A) | MAX. DF AT + 25 °C (%) | MAX. ESR AT + 25 °C 100 kHz (Ω) | MAX. RIPPLE 100 kHz I_{RMS} (A) |
| 2.5 V_{DC} AT + 85 °C; 1.6 V_{DC} AT + 125 °C | | | | | | |
| 220 | P | TR8P227M2R5C1500 | 11.0 | 30 | 1.50 | 0.129 |
| 4 V_{DC} AT + 85 °C; 2.7 V_{DC} AT + 125 °C | | | | | | |
| 33 | M | TR8M336M004C1500 | 2.6 | 30 | 1.50 | 0.129 |
| 47 | M | TR8M476M004C1500 | 3.8 | 40 | 1.50 | 0.129 |
| 100 | P | TR8P107M004C1500 | 4.0 | 30 | 1.50 | 0.173 |
| 220 | P | TR8P227(1)004C1000 | 17.6 | 30 | 1.00 | 0.212 |
| 220 | Q | TR8Q227M004C1200 | 88.0 | 80 | 1.20 | 0.214 |
| 6.3 V_{DC} AT + 85 °C; 4 V_{DC} AT + 125 °C | | | | | | |
| 10 | M | TR8M106(1)6R3C2000 | 0.6 | 8 | 2.00 | 0.112 |
| 15 | M | TR8M156M6R3C3000 | 0.9 | 20 | 3.00 | 0.091 |
| 22 | M | TR8M226M6R3C1500 | 2.8 | 20 | 1.50 | 0.129 |
| 33 | M | TR8M336M6R3C1500 | 4.2 | 30 | 1.50 | 0.129 |
| 100 | P | TR8P107M6R3C1500 | 6.3 | 30 | 1.50 | 0.173 |
| 100 | A | TR8A107M6R3C0500 | 6.3 | 20 | 0.50 | 0.390 |
| 10 V_{DC} AT + 85 °C; 7 V_{DC} AT + 125 °C | | | | | | |
| 2.2 | M | TR8M225M010C4000 | 0.5 | 10 | 4.00 | 0.079 |
| 4.7 | M | TR8M475M010C3000 | 0.5 | 6 | 3.00 | 0.079 |
| 10 | M | TR8M106M010C2000 | 1.0 | 20 | 2.00 | 0.112 |
| 15 | M | TR8M156(1)010C3000 | 1.5 | 30 | 3.00 | 0.091 |
| 33 | P | TR8P336M010C2500 | 3.3 | 20 | 2.50 | 0.134 |
| 47 | P | TR8P476M010C0800 | 4.7 | 22 | 0.80 | 0.237 |
| 47 | P | TR8P476M010C1000 | 4.7 | 22 | 1.00 | 0.212 |
| 16 V_{DC} AT + 85 °C; 10 V_{DC} AT + 125 °C | | | | | | |
| 1.0 | M | TR8M105(1)016C9500 | 0.5 | 6 | 9.50 | 0.050 |
| 2.2 | M | TR8M225M016C4000 | 0.5 | 10 | 4.00 | 0.079 |
| 4.7 | M | TR8M475M016C4000 | 0.8 | 8 | 4.00 | 0.079 |
| 4.7 | M | TR8M475M016C9000 | 0.8 | 8 | 9.00 | 0.053 |
| 10 | R | TR8R106M016C5000 | 1.6 | 8 | 5.00 | 0.095 |
| 25 V_{DC} AT + 85 °C; 17 V_{DC} AT + 125 °C | | | | | | |
| 10 | A | TR8A106M025C2500 | 2.5 | 10 | 2.50 | 0.173 |

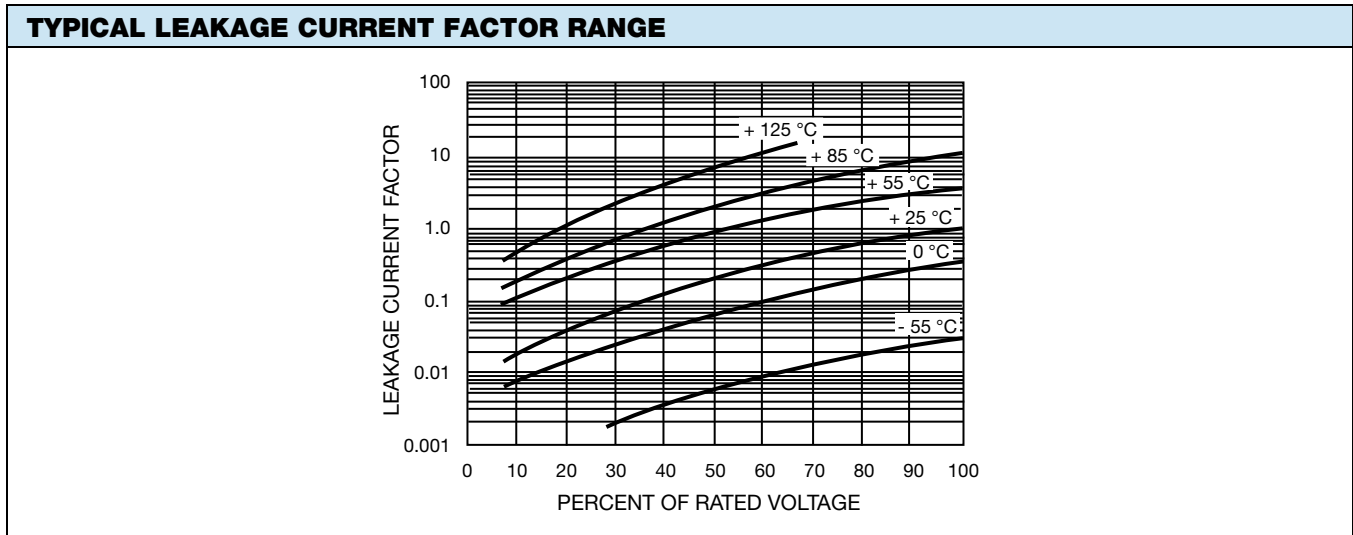
Note

- Part number definition:
 - (1) Tolerance: For 10 % tolerance, specify "K"; for 20 % tolerance, change to "M"



CAPACITORS PERFORMANCE CHARACTERISTICS

| ELECTRICAL PERFORMANCE CHARACTERISTICS | | | | |
|--|--|--------------------------|--------------------------|--------------------------|
| ITEM | PERFORMANCE CHARACTERISTICS | | | |
| Category Temperature Range | - 55 °C to + 85 °C (to + 125 °C with voltage derating) | | | |
| Capacitance Tolerance | ± 20 %, ± 10 %, tested via bridge method, at 25 °C, 120 Hz | | | |
| Dissipation Factor (at 120 Hz) | Limits per Standard Ratings table. Tested via bridge method, at 25 °C, 120 Hz. | | | |
| ESR (100 kHz) | Limits per Standard Ratings table. Tested via bridge method, at 25 °C, 100 kHz. | | | |
| Leakage Current | After application of rated voltage applied to capacitors for 5 min using a steady source of power with 1 kΩ resistor in series with the capacitor under test, leakage current at 25 °C is not more than described in Standard Ratings table. Note that the leakage current varies with temperature and applied voltage. See graph below for the appropriate adjustment factor. | | | |
| Reverse Voltage | Capacitors are capable of withstanding peak voltages in the reverse direction equal to: 10 % of the DC rating at + 25 °C 5 % of the DC rating at + 85 °C 1 % of the DC rating at + 125 °C Vishay does not recommend intentional or repetitive application of reverse voltage | | | |
| Temperature Derating | If capacitors are to be used at temperatures above + 25 °C, the permissible RMS ripple current or voltage shall be calculated using the derating factors: 1.0 at + 25 °C 0.9 at + 85 °C 0.4 at + 125 °C | | | |
| Operating Temperature | + 85 °C RATING | | + 125 °C RATING | |
| | RATED VOLTAGE (V) | SURGE VOLTAGE (V) | RATED VOLTAGE (V) | SURGE VOLTAGE (V) |
| | 2.5 | 3.3 | 1.7 | 2.2 |
| | 4.0 | 5.2 | 2.7 | 3.4 |
| | 6.3 | 8.0 | 4.0 | 5.0 |
| | 10 | 13 | 7.0 | 8.0 |
| | 16 | 20 | 10 | 12 |
| | 20 | 26 | 13 | 16 |
| | 25 | 32 | 17 | 20 |
| 35 | 46 | 23 | 28 | |
| 50 | 65 | 33 | 40 | |



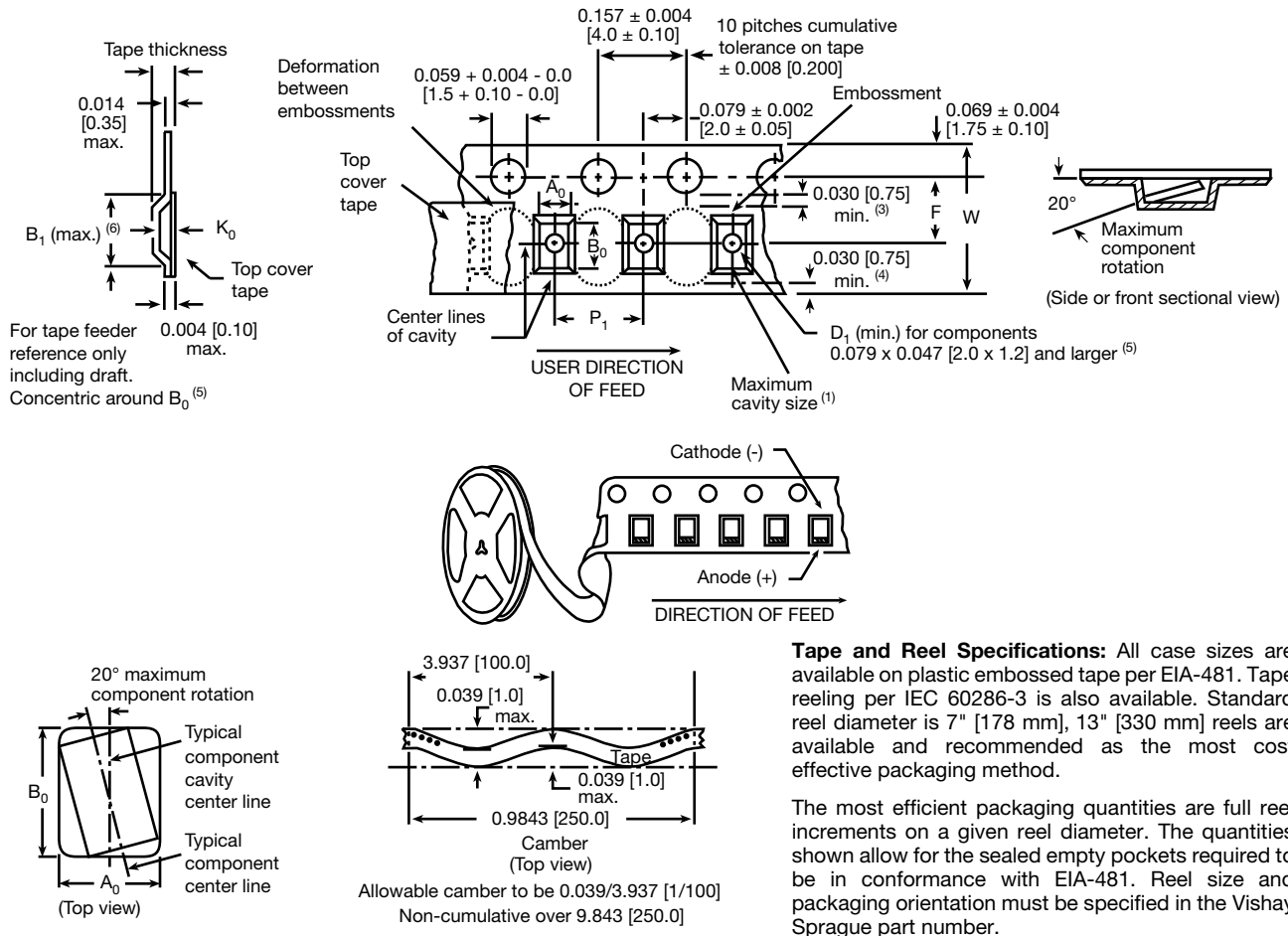
Notes

- At + 25 °C, the leakage current shall not exceed the value listed in the Standard Ratings table.
- At + 85 °C, the leakage current shall not exceed 10 times the value listed in the Standard Ratings table.
- At + 125 °C, the leakage current shall not exceed 12 times the value listed in the Standard Ratings table.



| ENVIRONMENTAL PERFORMANCE CHARACTERISTICS | | |
|---|--|--|
| ITEM | CONDITION | POST TEST PERFORMANCE |
| Life Test at + 85 °C | 1000 h application of rated voltage at 85 °C with a 3 Ω series resistance, MIL-STD-202 method 108A | Capacitance change ± 30 % Dissipation factor Not to exceed 150 % of initial Leakage current Not to exceed 200 % of initial |
| Humidity Test | At 40 °C/90 % RH 500 h, no voltage applied. MIL-STD-202 method 103B | Capacitance change ± 30 % Dissipation factor Not to exceed 150 % of initial Leakage current Not to exceed 200 % of initial |
| Thermal Shock | At - 55 °C/+ 125 °C, 30 min each, for 5 cycles. MIL-STD-202 method 107G | Capacitance change ± 30 % Dissipation factor Not to exceed 150 % of initial Leakage current Not to exceed 200 % of initial |

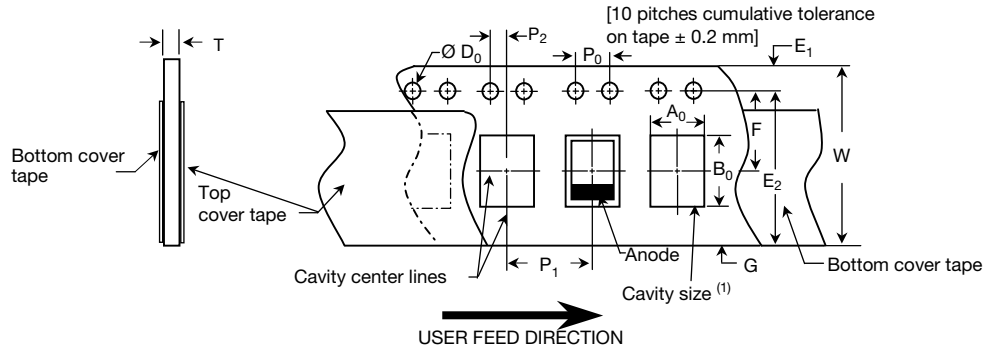
| MECHANICAL PERFORMANCE CHARACTERISTICS | | |
|--|--|---|
| ITEM | CONDITION | POST TEST PERFORMANCE |
| Terminal Strength | Apply a pressure load of 5 N for 10 s ± 1 s horizontally to the center of capacitor side body. AEC Q-200 rev. C method 006 | There shall be no visual damage when viewed at 20 x magnification and the component shall meet the original electrical requirements. |
| Vibration | MIL-STD-202, method 204D, 10 Hz to 2000 Hz, 20 g peak | Capacitance change ± 10 % Dissipation factor Initial specified value or less Leakage current Initial specified value or less ESR Initial specified value or less There shall be no mechanical or visual damage to capacitors post-conditioning. |
| Shock | MIL-STD-202, method 213B, condition I, 100 g peak | Capacitance change ± 10 % Dissipation factor Initial specified value or less Leakage current Initial specified value or less ESR Initial specified value or less There shall be no mechanical or visual damage to capacitors post-conditioning. |
| Resistance to Solder Heat | MIL-STD-202, method 210F, condition K | Capacitance change ± 30 % Dissipation factor Not to exceed 150 % of initial Leakage current Not to exceed 200 % of initial There shall be no mechanical or visual damage to capacitors post-conditioning. |
| Solderability | MIL-STD-202, method 208H, ANSI/J-STD-002, Test B. Applies only to solder and tin plated terminations. Does not apply to gold terminations. | All terminations shall exhibit a continuous solder coating free from defects for a minimum of 95 % of the critical area of any individual lead. |
| Resistance to Solvents | MIL-STD-202, method 215D | Marking has to remain legible, no degradation of encapsulation material. |
| Flammability | Encapsulation materials meet UL 94 V-0 with an oxygen index of 32 % | |

PLASTIC TAPE AND REEL PACKAGING in inches [millimeters]

Notes

- Metric dimensions will govern. Dimensions in inches are rounded and for reference only.
- (1) A_0 , B_0 , K_0 , are determined by the maximum dimensions to the ends of the terminals extending from the component body and/or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A_0 , B_0 , K_0) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20° .
- (2) Tape with components shall pass around radius "R" without damage. The minimum trailer length may require additional length to provide "R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum.
- (3) This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less.
- (4) This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier tape between the embossed cavity or to the edge of the cavity whichever is less.
- (5) The embossed hole location shall be measured from the sprocket hole controlling the location of the embossement. Dimensions of embossement location shall be applied independent of each other.
- (6) B_1 dimension is a reference dimension tape feeder clearance only.

CARRIER TAPE DIMENSIONS in inches [millimeters]

| CASE CODE | TAPE SIZE | B_1 (MAX.) | D_1 (MIN.) | F | K_0 (MAX.) | P_1 | W |
|-----------|-----------|--------------|--------------|------------------------------------|--------------|-----------------------------------|---|
| P, R | 8 mm | 0.108 [2.75] | 0.039 [1.0] | 0.138 ± 0.002 [3.5 \pm 0.05] | 0.054 [1.37] | 0.157 ± 0.004 [4.0 \pm 1.0] | $0.315 + 0.0118/- 0.0039$ [8.0 + 0.30/- 0.10] |
| Q, A | 8 mm | 0.165 [4.2] | 0.039 [1.0] | 0.138 ± 0.002 [3.5 \pm 0.05] | 0.094 [2.4] | 0.157 ± 0.004 [4.0 \pm 1.0] | 0.315 ± 0.012 [8.0 \pm 0.30] |

PAPER TAPE AND REEL PACKAGING in inches [millimeters]


| CASE SIZE | TAPE SIZE | A ₀ | B ₀ | D ₀ | P ₀ | P ₁ | P ₂ | E | F | W | T |
|-----------|-----------|--------------------------------|-------------------------------|-----------------------------|------------------------------|------------------------------|-------------------------------|-------------------------------|--------------------------------|------------------------------|--------------------------------|
| M | 8 mm | 0.041 ± 0.002 [1.05 ± 0.05] | 0.071 ± 0.002 [1.8 ± 0.05] | 0.06 ± 0.004 [1.5 ± 0.1] | 0.157 ± 0.004 [4.0 ± 0.1] | 0.157 ± 0.004 [4.0 ± 0.1] | 0.079 ± 0.002 [2.0 ± 0.05] | 0.069 ± 0.004 [1.75 ± 0.1] | 0.0138 ± 0.002 [3.5 ± 0.05] | 0.315 ± 0.008 [8.0 ± 0.2] | 0.037 ± 0.002 [0.95 ± 0.05] |

Note

(1) A₀, B₀ are determined by the maximum dimensions to the ends of the terminals extending from the component body and/or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°.

STANDARD PACKAGING QUANTITY

| CASE CODE | QUANTITY (PCS/REEL) |
|-----------|---------------------|
| | 7" REEL |
| M | 4000 |
| R | 2500 |
| P | 3000 |
| Q | 2500 |
| A | 2000 |

RECOMMENDED VOLTAGE DERATING GUIDELINES
STANDARD CONDITIONS. FOR EXAMPLE: OUTPUT FILTERS

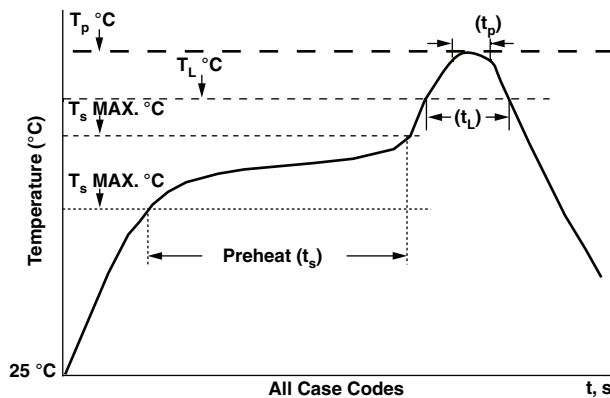
| Capacitor Voltage Rating | Operating Voltage |
|--------------------------|-------------------|
| 4.0 | 2.5 |
| 6.3 | 3.6 |
| 10 | 6.0 |
| 16 | 10 |
| 20 | 12 |
| 25 | 15 |
| 35 | 24 |
| 50 | 28 |

SEVERE CONDITIONS. FOR EXAMPLE: INPUT FILTERS

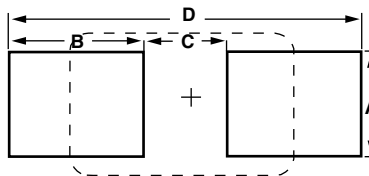
| Capacitor Voltage Rating | Operating Voltage |
|--------------------------|-------------------|
| 4.0 | 2.5 |
| 6.3 | 3.3 |
| 10 | 5.0 |
| 16 | 8.0 |
| 20 | 10 |
| 25 | 12 |
| 35 | 15 |
| 50 | 24 |

POWER DISSIPATION

| CASE CODE | MAXIMUM PERMISSIBLE POWER DISSIPATION AT + 25 °C (W) IN FREE AIR |
|-----------|--|
| M | 0.025 |
| R | 0.045 |
| P | 0.045 |
| Q | 0.055 |
| A | 0.075 |

RECOMMENDED REFLOW PROFILES


| T_P lead (Pb)-free | T_P Sn/Pb | t_p | T_L lead (Pb)-free | T_L Sn/Pb | T_S MIN. lead (Pb)-free | T_S MIN. Sn/Pb | T_S MAX. lead (Pb)-free | t_s MAX. Sn/Pb | t_s lead (Pb)-free | T_S Sn/Pb | t_L |
|-------------------------|----------------|-------|-------------------------|----------------|------------------------------|---------------------|------------------------------|---------------------|-------------------------|----------------|-------|
| 260 °C | 225 °C | 10 | 217 °C | 183 °C | 150 °C | 100 °C | 200 °C | 150 °C | 60 to 150 | 60 to 90 | 60 |

PAD DIMENSIONS in inches [millimeters]


| CASE CODE | A (MIN.) | B (NOM.) | C (NOM.) | D (NOM.) |
|-----------|--------------|--------------|--------------|--------------|
| M | 0.039 [1.00] | 0.028 [0.70] | 0.024 [0.60] | 0.080 [2.00] |
| R | 0.059 [1.50] | 0.031 [0.80] | 0.039 [1.0] | 0.102 [2.60] |
| P | 0.063 [1.60] | 0.031 [0.80] | 0.047 [1.20] | 0.110 [2.80] |
| Q | 0.071 [1.80] | 0.067 [1.70] | 0.053 [1.35] | 0.187 [4.75] |
| A | 0.071 [1.80] | 0.067 [1.70] | 0.053 [1.35] | 0.187 [4.75] |

GUIDE TO APPLICATION

1. **AC Ripple Current:** The maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = Power dissipation in watts at + 25 °C (see paragraph number 5 and the table Power Dissipation)

R_{ESR} = The capacitor equivalent series resistance at the specified frequency

2. **AC Ripple Voltage:** The maximum allowable ripple voltage shall be determined from the formula:

$$V_{RMS} = Z \sqrt{\frac{P}{R_{ESR}}}$$

or, from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

where,

P = Power dissipation in watts at + 25 °C (see paragraph number 5 and the table Power Dissipation)

R_{ESR} = The capacitor equivalent series resistance at the specified frequency

Z = The capacitor impedance at the specified frequency

- 2.1 The sum of the peak AC voltage plus the applied DC voltage shall not exceed the DC voltage rating of the capacitor.
- 2.2 The sum of the negative peak AC voltage plus the applied DC voltage shall not allow a voltage reversal exceeding 10 % of the DC working voltage at + 25 °C.
3. **Reverse Voltage:** These capacitors are capable of withstanding peak voltages in the reverse direction equal to 10 % of the DC rating at + 25 °C, 5 % of the DC rating at + 85 °C and 1 % of the DC rating at + 125 °C.
4. **Temperature Derating:** If these capacitors are to be operated at temperatures above + 25 °C, the permissible RMS ripple current or voltage shall be calculated using the derating factors as shown:

| TEMPERATURE | DERATING FACTOR |
|-------------|-----------------|
| + 25 °C | 1.0 |
| + 85 °C | 0.9 |
| + 125 °C | 0.4 |

5. **Power Dissipation:** Power dissipation will be affected by the heat sinking capability of the mounting surface. Non-sinusoidal ripple current may produce heating effects which differ from those shown. It is important that the equivalent I_{RMS} value be established when calculating permissible operating levels. (Power Dissipation calculated using + 25 °C temperature rise.)

6. **Printed Circuit Board Materials:** Molded capacitors are compatible with commonly used printed circuit board materials (alumina substrates, FR4, FR5, G10, PTFE-fluorocarbon and porcelainized steel).

7. **Attachment:**

- 7.1 **Solder Paste:** The recommended thickness of the solder paste after application is 0.007" ± 0.001" [0.178 mm ± 0.025 mm]. Care should be exercised in selecting the solder paste. The metal purity should be as high as practical. The flux (in the paste) must be active enough to remove the oxides formed on the metallization prior to the exposure to soldering heat. In practice this can be aided by extending the solder preheat time at temperatures below the liquidous state of the solder.

- 7.2 **Soldering:** Capacitors can be attached by conventional soldering techniques; vapor phase, convection reflow, infrared reflow, wave soldering and hot plate methods. The Soldering Profile charts show recommended time/temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 2 °C per s. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor.

- 7.2.1 **Backward and Forward Compatibility:** Capacitors with SnPb or 100 % tin termination finishes can be soldered using SnPb or lead (Pb)-free soldering processes.

8. **Cleaning (Flux Removal) After Soldering:** Molded capacitors are compatible with all commonly used solvents such as TES, TMS, Prelete, Chloroethane, Terpene and aqueous cleaning media. However, CFC/ODS products are not used in the production of these devices and are not recommended. Solvents containing methylene chloride or other epoxy solvents should be avoided since these will attack the epoxy encapsulation material.

- 8.1 When using ultrasonic cleaning, the board may resonate if the output power is too high. This vibration can cause cracking or a decrease in the adherence of the termination. Do not exceed 9W/l at 40 kHz for 2 min.

9. **Recommended Mounting Pad Geometries:** Proper mounting pad geometries are essential for successful solder connections. These dimensions are highly process sensitive and should be designed to minimize component rework due to unacceptable solder joints. The dimensional configurations shown are the recommended pad geometries for both wave and reflow soldering techniques. These dimensions are intended to be a starting point for circuit board designers and may be fine tuned if necessary based upon the peculiarities of the soldering process and/or circuit board design.

| PRODUCT INFORMATION | |
|--------------------------------|--|
| Micro Guide | www.vishay.com/doc?40115 |
| Moisture Sensitivity | www.vishay.com/doc?40135 |
| SELECTOR GUIDES | |
| Solid Tantalum Selector Guide | www.vishay.com/doc?49053 |
| Solid Tantalum Chip Capacitors | www.vishay.com/doc?40091 |
| FAQ | |
| Frequently Asked Questions | www.vishay.com/doc?40110 |



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Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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